## **Notice for TAIYO YUDEN products**

Please read this notice before using the TAIYO YUDEN products.

#### **REMINDERS**

#### Product Information in this Catalog

Product information in this catalog is as of January 2021. All of the contents specified herein and production status of the products listed in this catalog are subject to change without notice due to technical improvement of our products, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

#### Approval of Product Specifications

Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available. When using our products, please be sure to approve our product specifications or make a written agreement on the product specification with TAIYO YUDEN in advance.

#### Pre-Evaluation in the Actual Equipment and Conditions

Please conduct validation and verification of our products in actual conditions of mounting and operating environment before using our products.

#### Limited Application

#### 1. Equipment Intended for Use

The products listed in this catalog are intended for generalpurpose and standard use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and other equipment specified in this catalog or the individual product specification sheets.

TAIYO YUDEN has the line-up of the products intended for use in automotive electronic equipment, telecommunications infrastructure and industrial equipment, or medical devices classified as GHTF Classes A to C (Japan Classes I to III). Therefore, when using our products for these equipment, please check available applications specified in this catalog or the individual product specification sheets and use the corresponding products.

#### 2. Equipment Requiring Inquiry

Please be sure to contact TAIYO YUDEN for further information before using the products listed in this catalog for the following equipment (excluding intended equipment as specified in this catalog or the individual product specification sheets) which may cause loss of human life, bodily injury, serious property damage and/or serious public impact due to a failure or defect of the products and/or malfunction attributed thereto.

- (1) Transportation equipment (automotive powertrain control system, train control system, and ship control system, etc.)
- (2) Traffic signal equipment
- (3) Disaster prevention equipment, crime prevention equipment
- (4) Medical devices classified as GHTF Class C (Japan Class III)
- (5) Highly public information network equipment, dataprocessing equipment (telephone exchange, and base station, etc.)
- (6) Any other equipment requiring high levels of quality and/or reliability equal to the equipment listed above

#### 3. Equipment Prohibited for Use

Please do not incorporate our products into the following equipment requiring extremely high levels of safety and/or reliability.

- (1) Aerospace equipment (artificial satellite, rocket, etc.)
- (2) Aviation equipment \*1
- (3) Medical devices classified as GHTF Class D (Japan Class IV), implantable medical devices \*2

- (4) Power generation control equipment (nuclear power, hydroelectric power, thermal power plant control system, etc.)
- (5) Undersea equipment (submarine repeating equipment, underwater work equipment, etc.)
- (6) Military equipment
- Any other equipment requiring extremely high levels of safety and/or reliability equal to the equipment listed above

- 1. There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.
- 2. Implantable medical devices contain not only internal unit which is implanted in a body, but also external unit which is connected to the internal unit.

#### 4. Limitation of Liability

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment that is not intended for use by TAIYO YUDEN, or any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

#### Safety Design

When using our products for high safety and/or reliability-required equipment or circuits, please fully perform safety and/or reliability evaluation. In addition, please install (i) systems equipped with a protection circuit and a protection device and/or (ii) systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault for a failsafe design to ensure safety.

#### Intellectual Property Rights

Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.

#### Limited Warranty

Please note that the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a failure or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such

#### ■ TAIYO YUDEN's Official Sales Channel

The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.

#### Caution for Export

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our product specification sheets. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our website (http://www.ty-top.com/)

## WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES)

REFLOW

#### PARTS NUMBER

\* Operating Temp.: -40~+105°C (Including self-generated heat)

△=Blank space



1) Series	name

TOCITES Harrie	
Code	Series name
СВ	Wound chip power inductor

#### (2) Characteristics

Z Offar acteristics	5	
Code	Characteristics	
ΔΔ	Standard	
ΔC	High current	
ΔL	Low profile	
MF	Low loss	

#### ③Dimensions(L×W)

Code	Type (inch)	Dimensions (L×W)[mm]
1608	1608 (0603)	1.6 × 0.8
2012	2012(0805)	2.0 × 1.25
2016	2016 (0806)	2.0 × 1.6
2518	2518(1007)	2.5 × 1.8
3225	3225(1210)	3.2 × 2.5

#### 4 Packaging

Code	Packaging
Т	Taping

#### (5)Nominal inductance

Code (example)	Nominal inductance[ $\mu$ H]
1R0	1.0
100	10
101	100

※R=Decimal point

#### 6Inductance tolerance

Code	Inductance tolerance		
K	±10%		
М	±20%		

#### 7Special code

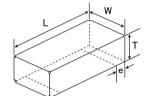
Code	Special code	
Δ	Standard	
R	Low Rdc type	

8Internal code

#### ■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY

CB/CB C/CB L





#### Recommended Land Patterns

Surface Mounting

•Mounting and soldering conditions should be checked beforehand.

\*Applicable soldering process to these products is reflow soldering only.

			С
<del>-</del> А	<b>→</b> B	<u>А</u>	

Type	Α	В	С
MF1608	0.55	0.7	1.0
2012	0.60	1.0	1.45
2016	0.60	1.0	1.8
2518	0.60	1.5	2.0
3225	0.85	1.7	2.7

Unit:mm

T	L W	I VA	т .		Standard quantity[pcs]	
Туре	L	VV	_	е	Paper tape	Embossed tape
CBMF1608	1.6±0.2 (0.063±0.008)	$0.8\pm0.2$ (0.031±0.008)	$0.8 \pm 0.2$ (0.031 $\pm 0.008$ )	0.45±0.15 (0.016±0.006)	_	3000
CB L2012	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	0.9±0.1 (0.035±0.004)	0.5±0.2 (0.020±0.008)	4000	_
CB 2012 CB C2012	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	1.25±0.2 (0.049±0.008)	0.5±0.2 (0.020±0.008)	_	3000
CB 2016 CB C2016	2.0±0.2 (0.079±0.008)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	0.5±0.2 (0.020±0.008)	_	2000
CB 2518 CB C2518	2.5±0.2 (0.098±0.008)	1.8±0.2 (0.071±0.008)	1.8±0.2 (0.071±0.008)	0.5±0.2 (0.020±0.008)	_	2000
CB C3225	3.2±0.2 (0.126±0.008)	2.5±0.2 (0.098±0.008)	2.5±0.2 (0.098±0.008)	0.6±0.3 (0.024±0.012)	_	1000

Unit:mm(inch)

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## for General Electronic Equipment

#### ■PARTS NUMBER

1608	(0603)type
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		Nominal inductance [ μ H]	Inductance tolerance	Self-resonant	DC Resistance	Rated curren	t ※)[mA]	Measuring frequency[MHz]
Parts number	EHS			frequency [MHz] (min.)	[Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	
CBMF1608T1R0M	RoHS	1.0	±20%	100	0.09	290	770	7.96
CBMF1608T2R2M	RoHS	2.2	±20%	80	0.17	190	560	7.96
CBMF1608T3R3M	RoHS	3.3	±20%	60	0.22	170	500	7.96
CBMF1608T4R7M	RoHS	4.7	±20%	45	0.24	145	470	7.96
CBMF1608T100[]	RoHS	10	±10%, ±20%	32	0.36	115	380	2.52
CBMF1608T220[]	RoHS	22	±10%, ±20%	16	1.0	70	230	2.52
CBMF1608T470[]	RoHS	47	±10%, ±20%	11	2.5	50	140	2.52

#### **2012** (0805) type

		Nominal inductance	Inductance tolerance	Self-resonant	DC Resistance	Rated curren	t ※)[mA]	Measuring
Parts number	EHS	[ μ H]		frequency [MHz] (min.)	$[\Omega](\pm 30\%)$	Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]
CB 2012T1R0M	RoHS	1.0	±20%	100	0.15	500	900	7.96
CB 2012T2R2M	RoHS	2.2	±20%	80	0.23	410	770	7.96
CB 2012T3R3M	RoHS	3.3	±20%	55	0.30	330	650	7.96
CB 2012T4R7M	R₀HS	4.7	±20%	45	0.40	300	580	7.96
CB 2012T6R8M	R₀HS	6.8	±20%	38	0.47	250	540	7.96
CB 2012T100[]	RoHS	10	±10%, ±20%	32	0.70	190	440	2.52
CB 2012T100[R	R₀HS	10	±10%, ±20%	32	0.50	200	520	2.52
CB 2012T150[]	RoHS	15	±10%, ±20%	28	1.3	170	320	2.52
CB 2012T220[]	RoHS	22	±10%, ±20%	16	1.7	135	280	2.52
CB 2012T470[]	RoHS	47	±10%, ±20%	11	3.7	90	190	2.52
CB 2012T680[]	RoHS	68	±10%, ±20%	10	6.0	70	140	2.52
CB 2012T101[]	RoHS	100	±10%, ±20%	8	7.0	60	130	0.796

Parts number		Nominal inductance [ μ H]	Inductance tolerance	Self-resonant	DC Resistance [Ω](±30%)	Rated curren	Measuring	
	EHS			frequency [MHz] (min.)		Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]
CB C2012T1R0M	RoHS	1.0	±20%	100	0.19	700	840	7.96
CB C2012T2R2M	RoHS	2.2	±20%	70	0.33	530	640	7.96
CB C2012T4R7M	RoHS	4.7	±20%	45	0.50	360	520	7.96
CB C2012T100[]	RoHS	10	±10%, ±20%	40	1.2	240	340	2.52
CB C2012T220[]	RoHS	22	±10%, ±20%	16	3.7	170	190	2.52
CB C2012T470[]	RoHS	47	±10%, ±20%	11	5.8	120	150	2.52

Parts number		Nominal inductance [ μ H]	Inductance tolerance	Self-resonant	DC Resistance [Ω](±30%)	Rated current ※) [mA]		Measuring
	EHS			frequency [MHz] (min.)		Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]
CB L2012T1R0M	RoHS	1.0	±20%	100	0.15	620	950	0.1
CB L2012T2R2M	RoHS	2.2	±20%	80	0.39	440	590	0.1
CB L2012T4R7M	RoHS	4.7	±20%	45	0.66	275	490	0.1
CB L2012T100M	RoHS	10	±20%	32	1.0	205	370	0.1
CB L2012T220M	RoHS	22	±20%	23	2.1	150	250	0.1
CB L2012T470M	RoHS	47	±20%	11	4.2	100	140	0.1

#### **2016**(0806) type

		Nominal inductance		Self-resonant	DO De distance	Rated curren	t ※)[mA]	Manager
Parts number	EHS	[ μ H]	Inductance tolerance	frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]
CB 2016T1R0M	RoHS	1.0	±20%	100	0.09	600	1,100	7.96
CB 2016T1R5M	RoHS	1.5	±20%	80	0.11	550	1,000	7.96
CB 2016T2R2M	RoHS	2.2	±20%	70	0.13	510	1,000	7.96
CB 2016T3R3M	RoHS	3.3	±20%	55	0.20	400	800	7.96
CB 2016T4R7M	RoHS	4.7	±20%	45	0.25	340	740	7.96
CB 2016T6R8M	RoHS	6.8	±20%	38	0.35	300	600	7.96
CB 2016T100[]	R₀HS	10	±10%, ±20%	32	0.50	250	520	2.52
CB 2016T150[]	R₀HS	15	±10%, ±20%	28	0.70	210	440	2.52
CB 2016T220[]	RoHS	22	±10%, ±20%	16	1.0	165	370	2.52
CB 2016T330[]	RoHS	33	±10%, ±20%	14	1.7	130	270	2.52
CB 2016T470[]	RoHS	47	±10%, ±20%	11	2.4	110	240	2.52
CB 2016T680[]	R₀HS	68	±10%, ±20%	10	3.0	90	210	2.52
CB 2016T101[]	R₀HS	100	±10%, ±20%	8	4.5	70	170	0.796

<sup>•</sup>  $\hfill\Box$  Please specify the Inductance tolerance code (Kor M)

<sup>%</sup>) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30% ( at 20°C) %) The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C.( at 20°C)

 $<sup>\</sup>mbox{\ensuremath{\mbox{\%}}})\mbox{\ensuremath{\mbox{The}}}$  rated current value is following either Idc1 or Idc2, which is the lower one.

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		Nominal inductance		Self-resonant	DC Resistance	Rated currer	nt ※)[mA]	Measuring
Parts number	EHS	[ $\mu$ H]	Inductance tolerance	frequency [MHz] (min.)	$[\Omega](\pm 30\%)$	Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]
CB C2016T1R0M	RoHS	1.0	±20%	100	0.10	1,100	1,100	7.96
CB C2016T1R5M	RoHS	1.5	±20%	80	0.15	1,000	1,000	7.96
CB C2016T2R2M	RoHS	2.2	±20%	70	0.20	750	720	7.96
CB C2016T3R3M	RoHS	3.3	±20%	55	0.27	600	610	7.96
CB C2016T4R7M	RoHS	4.7	±20%	45	0.37	550	530	7.96
CB C2016T6R8M	RoHS	6.8	±20%	38	0.59	450	450	7.96
CB C2016T100[]	RoHS	10	±10%, ±20%	32	0.82	380	350	2.52
CB C2016T150[]	RoHS	15	±10%, ±20%	28	1.2	300	300	2.52
CB C2016T220[]	RoHS	22	±10%, ±20%	16	1.8	250	240	2.52
CB C2016T330[]	RoHS	33	±10%, ±20%	14	2.8	220	220	2.52
CB C2016T470[]	RoHS	47	±10%, ±20%	11	4.3	150	150	2.52
CB C2016T680[]	RoHS	68	±10%, ±20%	10	7.0	130	130	2.52
CB C2016T101[]	RoHS	100	±10%, ±20%	8	8.0	110	110	0.796

2518(1007)type

		Ni andro di Santo de Cara		Self-resonant	DO Desistence	Rated curren	t ※)[mA]	Managed
Parts number	EHS	Nominal inductance [ μ H]	Inductance tolerance	frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]
CB 2518T1R0M	RoHS	1.0	±20%	100	0.06	1,200	1,500	7.96
CB 2518T1R5M	RoHS	1.5	±20%	80	0.07	650	1,400	7.96
CB 2518T2R2M	RoHS	2.2	±20%	68	0.09	510	1,300	7.96
CB 2518T3R3M	RoHS	3.3	±20%	54	0.11	440	1,200	7.96
CB 2518T4R7MR	RoHS	4.7	±20%	46	0.10	310	1,200	7.96
CB 2518T4R7M	RoHS	4.7	±20%	46	0.13	340	1,100	7.96
CB 2518T6R8M	RoHS	6.8	±20%	38	0.15	270	930	7.96
CB 2518T100[]	RoHS	10	±10%, ±20%	30	0.25	250	820	2.52
CB 2518T150[]	RoHS	15	±10%, ±20%	23	0.32	180	650	2.52
CB 2518T220[]	RoHS	22	±10%, ±20%	19	0.50	165	580	2.52
CB 2518T330[]	RoHS	33	±10%, ±20%	15	0.70	130	460	2.52
CB 2518T470[]	RoHS	47	±10%, ±20%	12	0.95	110	420	2.52
CB 2518T680[]	RoHS	68	±10%, ±20%	9.5	1.5	70	310	2.52
CB 2518T101[]	RoHS	100	±10%, ±20%	9.0	2.1	60	260	0.796
CB 2518T151[]	RoHS	150	±10%, ±20%	7.0	3.2	55	210	0.796
CB 2518T221[]	RoHS	220	±10%, ±20%	5.5	4.5	50	180	0.796
CB 2518T331[]	RoHS	330	±10%, ±20%	4.5	7.0	40	140	0.796
CB 2518T471[]	RoHS	470	±10%, ±20%	3.5	10	35	120	0.796
CB 2518T681[]	RoHS	680	±10%, ±20%	3.0	17	30	90	0.796
CB 2518T102[	RoHS	1000	±10%, ±20%	2.4	24	25	75	0.252

		Manada al Carda akan ar		Self-resonant	DC Resistance	Rated currer	t ※)[mA]	Managedon
Parts number	EHS	Nominal inductance [ μ H]	Inductance tolerance	frequency [MHz] (min.)	[Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]
CB C2518T1R0M	RoHS	1.0	±20%	100	0.08	1,000	1,200	7.96
CB C2518T1R5M	RoHS	1.5	±20%	80	0.11	950	1,190	7.96
CB C2518T2R2M	RoHS	2.2	±20%	68	0.13	890	1,100	7.96
CB C2518T3R3M	RoHS	3.3	±20%	54	0.16	730	1,020	7.96
CB C2518T4R7M	RoHS	4.7	±20%	41	0.20	680	920	7.96
CB C2518T6R8M	RoHS	6.8	±20%	38	0.30	550	740	7.96
CB C2518T100[]	RoHS	10	±10%, ±20%	30	0.36	480	680	2.52
CB C2518T150[]	RoHS	15	±10%, ±20%	23	0.65	350	500	2.52
CB C2518T220[]	RoHS	22	±10%, ±20%	19	0.77	320	460	2.52
CB C2518T330[]	RoHS	33	±10%, ±20%	15	1.5	270	320	2.52
CB C2518T470[]	RoHS	47	±10%, ±20%	12	1.9	240	290	2.52
CB C2518T680[]	RoHS	68	±10%, ±20%	9.5	2.8	200	200	2.52
CB C2518T101[]	RoHS	100	±10%, ±20%	9.0	3.7	160	170	0.796
CB C2518T151[]	RoHS	150	±10%, ±20%	7.0	6.1	140	130	0.796
CB C2518T221[]	RoHS	220	±10%, ±20%	5.5	8.4	115	110	0.796
CB C2518T331[]	RoHS	330	±10%, ±20%	4.5	12.3	100	90	0.796
CB C2518T471[]	RoHS	470	±10%, ±20%	3.5	22	80	70	0.796
CB C2518T681[]	R₀HS	680	±10%, ±20%	3.0	28	65	60	0.796

<sup>• ☐</sup> Please specify the Inductance tolerance code (Kor M)

<sup>\*\*)</sup> The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C. (at 20°C)

\*\*) The rated current value is following either Idc1 or Idc2, which is the lower one.

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## for General Electronic Equipment

**3225** (1210) type

		N		Self-resonant	DO D	Rated curren	it ※)[mA]	
Parts number	EHS	Nominal inductance [ μ H]	Inductance tolerance	frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]
CB C3225T1R0MR	RoHS	1.0	±20%	250	0.055	2,000	1,440	0.1
CB C3225T1R5MR	RoHS	1.5	±20%	220	0.060	2,000	1,310	0.1
CB C3225T2R2MR	RoHS	2.2	±20%	190	0.080	2,000	1,130	0.1
CB C3225T3R3MR	RoHS	3.3	±20%	160	0.095	2,000	1,040	0.1
CB C3225T4R7MR	RoHS	4.7	±20%	70	0.100	1,250	1,010	0.1
CB C3225T6R8MR	RoHS	6.8	±20%	50	0.120	950	940	0.1
CB C3225T100∏R	RoHS	10	±10%, ±20%	23	0.133	900	900	0.1
CB C3225T150[]R	RoHS	15	±10%, ±20%	20	0.195	730	850	0.1
CB C3225T220[]R	RoHS	22	±10%, ±20%	17	0.27	620	780	0.1
CB C3225T330∏R	RoHS	33	±10%, ±20%	13	0.41	500	570	0.1
CB C3225T470[R	RoHS	47	±10%, ±20%	10	0.67	390	480	0.1
CB C3225T680∏R	RoHS	68	±10%, ±20%	8.0	1.0	320	410	0.1
CB C3225T101[R	RoHS	100	±10%, ±20%	6.0	1.4	270	340	0.1
CB C3225T221[]R	RoHS	220	±10%, ±20%	3.0	2.5	190	190	0.1
CB C3225T821[]R	RoHS	820	±10%, ±20%	1.8	12	110	110	0.1
CB C3225T102□R	RoHS	1000	±10%, ±20%	1.6	13	100	100	0.1

<sup>• []</sup> Please specify the Inductance tolerance code(Kor M)

2021

<sup>%</sup>) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%.( at 20°C) %) The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C.( at 20°C) %) The rated current value is following either Idc1 or Idc2, which is the lower one.

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# WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

3000

3000

#### **■**PACKAGING

1 Minimum Quantity

#### Standard Quantity [pcs] Туре Embossed Tape Paper Tape LB C3225 1000 CB C3225 LB 3218 2000 LB R2518 LB C2518 LB 2518 2000 CB 2518 CB C2518 LBM2016 LB C2016 LB 2016 2000 CB 2016

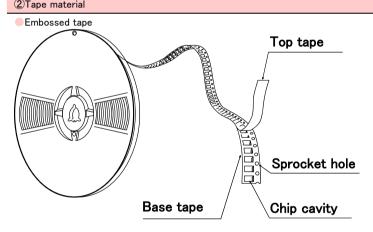
CBMF1608
2 Tana material

CB C2016 LB 2012 LB C2012

LB R2012 CB 2012 CB C2012 CB L2012

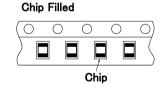
LB 1608

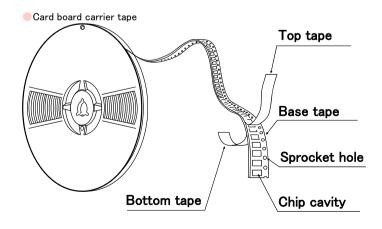
LBMF1608

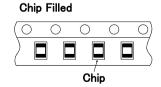


4000

4000

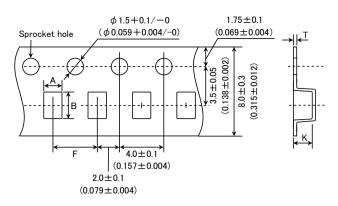






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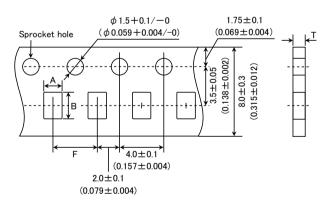
#### Embossed Tape (0.315 inches wide)



T	Chip	cavity	Insertion pitch	Tape th	ickness
Туре	Α	В	F	Т	K
LBM2016	1.75±0.1	2.1±0.1	4.0±0.1	0.3±0.05	1.9max.
	(0.069±0.004)	(0.083±0.004)	(0.157±0.004)	(0.012±0.002)	(0.075max.)
LB C3225	2.8±0.1	3.5±0.1	4.0±0.1	0.3±0.05	4.0max.
CB C3225	(0.110±0.004)	(0.138±0.004)	(0.157±0.004)	(0.012±0.002)	(0.157max.)
LB 3218	2.1±0.1	3.5±0.1	4.0±0.1	0.3±0.05	2.2max.
	(0.083±0.004)	(0.138±0.004)	(0.157±0.004)	(0.012±0.002)	(0.087max.)
LB 2518 CB 2518 LB C2518 CB C2518 LB R2518	2.15±0.1	2.7±0.1	4.0±0.1	0.3±0.05	2.2max.
	(0.085±0.004)	(0.106±0.004)	(0.157±0.004)	(0.012±0.002)	(0.087max.)
LB 2016 CB 2016 LB C2016 CB C2016	1.75±0.1 (0.069±0.004)	2.1±0.1 (0.083±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	1.9max. (0.075max.)
LB 2012 CB 2012 LB C2012 CB C2012 LB R2012	1.45±0.1 (0.057±0.004)	2.25±0.1 (0.089±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.010±0.002)	1.45max. (0.057max.)
LBMF1608	1.1±0.1	1.9±0.1	4.0±0.1	0.25±0.05	1.2max.
CBMF1608	(0.043±0.004)	(0.075±0.004)	(0.157±0.004)	(0.010±0.002)	(0.047max.)

Unit:mm(inch)

#### Card board carrier tape (0.315 inches wide)

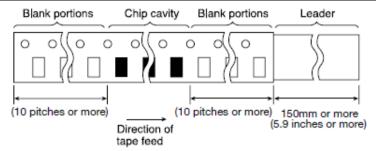


Turne	Chip	cavity	Insertion pitch	Tape thickness
Туре	Α	В	F	Т
CB L2012	1.55±0.1	2.3±0.1	4.0±0.1	1.1max.
	$(0.061 \pm 0.004)$	$(0.091 \pm 0.004)$	$(0.157 \pm 0.004)$	(0.043max.)
LB 1608	1.0±0.1	1.8±0.1	4.0±0.1	1.1max.
	$(0.039 \pm 0.004)$	$(0.071 \pm 0.004)$	$(0.157 \pm 0.004)$	(0.043max.)

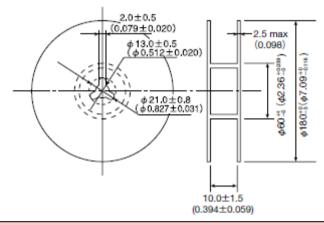
Unit:mm(inch)

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#### 4 Leader and Blank Portion

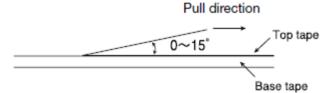


#### ⑤Reel Size



#### **6**Top Tape Strength

The top tape requires a peel-off force 0.2 to 0.7N in the direction of the arrow as illustrated below.



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# WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

#### ■RELIABILITY DATA

1.Operating tempera	ature Range			
, ,	LB, LBC, LBR, LBMF Series			
Specified Value	CB, CBC, CBL, CBMF Series	- -40~+105°C (Including self-generated heat)		
	LBM Series			
2. Storage Tempera	ture Range(after soldering)			
	LB, LBC, LBR, LBMF Series			
Specified Value	CB, CBC, CBL, CBMF Series	-40~+85°C		
	LBM Series			
Test Methods and Remarks	LB, CB Series: Please refer the term of "7. storage conditions" in precaut	tions.		
3.Rated Current				
	LB, LBC, LBR, LBMF Series			
Specified Value	CB, CBC, CBL, CBMF Series	Within the specified tolerance		
	LBM Series			
4.Inductance				
	LB, LBC, LBR, LBMF Series	Within the specified tolerance		
Specified Value	CB, CBC, CBL, CBMF Series			
	LBM Series			
Test Methods and Remarks	LB·LBC·LBR·CB·CBC·CBL·LBMF·CBMF·LBM Series  Measuring equipment : LCR Mater(HP4285A or it  Measuring frequency : Specified frequency	s equivalent)		
5.Q				
	LB, LBC, LBR, LBMF Series			
Specified Value	CB, CBC, CBL, CBMF Series			
	LBM Series	Within the specified tolerance		
Test Methods and Remarks	LBM Series  Measuring equipment : LCR Mater(HP4285A or its  Measuring frequency : Specified frequency	equivalent)		
6.DC Resisitance				
	LB, LBC, LBR, LBMF Series			
Specified Value	CB, CBC, CBL, CBMF Series	Within the specified tolerance		
	LBM Series			
Test Methods and Remarks	Measuring equipment : DC Ohmmeter (HIOKI 3227 or its e	equivalent)		
7.Self-Resonant Fro	equency			
	LB, LBC, LBR, LBMF Series			
Specified Value	CB, CBC, CBL, CBMF Series	Within the specified tolerance		
,	LBM Series			
Test Methods and Remarks	Measuring equipment : Impedance analyzer (HP4291A or i	ts equivalent)		

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8.Temperature Cha	8.Temperature Characteristic				
	LBM2016				Inductance change : Within±5%
	LB1608	LB2012	LBR2012	CB2012	
	CBL2012	LB2016	CB2016	LB2518	Inductance change : Within±20%
Specified Value	LBR2518	CB2518	LBC3225	CBC3225	
	LBMF1608	CBMF1608	LBC2016	CBC2016	The Mail 1950/
	LBC2518	CBC2518	LB3218		Inductance change : Within±25%
	LBC2012	CBC2012			Inductance change : Within±35%
Test Methods and Remarks	Based on the	inductance at 2	0°C and Measι	ured at the ambie	ent of −40°C~+85°C.

9.Rasistance to Fle	9.Rasistance to Flexure of Substrate				
	LB, LBC, LBR, LBMF Series	No damage.			
Specified Value	CB, CBC, CBL, CBMF Series				
	LBM Series				
Test Methods and Remarks	Warp : 2mm(LB·LBC·LBR·CB·CBC·CBL·LBM·L Test substrate : Glass epoxy-resin substrate Thickness : 0.8mm(LB1608·LBMF1608·CBMF1608) : 1.0mm(Others)  Pressing jig  10 20 R340  Board  R5  Board	BMF·CBMF Series)			

10.Body Strength		
	LB, LBC, LBR, LBMF Series	
Specified Value	CB, CBC, CBL, CBMF Series	No damage.
	LBM Series	
Test Methods and Remarks	LB·LBC·LBR·CB·CBC·CBL·LBM  Applied force : 10N  Duration : 10sec.  LB1608·LBMF1608·CBMF1608  Applied force : 5N  Duration : 10sec.	

11.Adhesion of terminal electrode				
	LB, LBC, LBR, LBMF Series			
Specified Value	CB, CBC, CBL, CBMF Series		No abnormality.	
	LBM Series			
Test Methods and Remarks	Applied force Duration Test substrate LB1608 • CBMF1608 • Applied force Duration	CBC • CBL • LBM • LBMF • CBMF : 10N to X and Y directions : 5 sec. : Printed board • LBMF1608 : 5N to X and Y directions : 5 sec. : Printed board		

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12.Resistance to vibration					
	LB, LBC, LBR, LBMF Series		Inductance change : Within±10%		
Specified Value	CB, CBC, CBL, CBMF Series		No significant abnormality in appearance.		
	LBM Series		Inductance change : Within±5%  No significant abnormality in appearance.		
	LB·LBR·LBC·CB·CBC·CBL·LBM·LBMF·CBMF:				
	The given sample is soldered t		d depending on the conditions of the following table.		
	Vibration Frequency	10~55Hz	100 (0)		
Test Methods and Remarks	Total Amplitude Sweeping Method	1.5mm (May not exceed acceled to 10Hz to 55Hz to 10Hz for 1min			
Remarks	Sweeping Method	X	I		
	Time	Y For 2 hours or	each X, Y, and Z axis.		
	Recovery : At least 2 hrs of		ondition after the test, followed by the measurement within 48 hrs.		
13.Drop test					
	LB, LBC, LBR, LBMF Series				
Specified Value	CB, CBC, CBL, CBMF Series		_		
	LBM Series				
			<u>L</u>		
14.Solderability					
14.50iderability	LD LDC LDD LDME Sorios				
0 : 11/1	LB, LBC, LBR, LBMF Series				
Specified Value	CB, CBC, CBL, CBMF Series		At least 90% of surface of terminal electrode is covered by new		
	LBM Series				
Test Methods and	LB·LBC·LBR·CB·CBC·CBL	∙LBM∙LBMF∙CBMF: 5±5°C			
Remarks	· ·	0.5sec			
		thanol solution with 25% of col	ophony		
15.Resistance to so	ldering				
	LB, LBC, LBR, LBMF Series				
Specified Value	CB. CBC. CBL. CBMF Series		Inductance change : Within±10%		
Specifica Value	LBM Series		Inductance change : Within±5%		
Test Methods and	LB·LBC·LBR·CB·CBC·CBL	I RM I RME CRME	Inductation of dialign. Within 2070		
Remarks		O°C MIN for 40sec. with peak te	mperature at 260 °C for 5sec.		
	Recovery : At least 2 hrs of	recovery under the standard co	ondition after the test, followed by the measurement within 48 hrs.		
16.Resisitance to se	olvent				
	LB, LBC, LBR, LBMF Series				
Specified Value	CB, CBC, CBL, CBMF Series		_		
	LBM Series				
	Solvent temperature : Roo	om temperature	L		
Test Methods and Remarks	Type of solvent : Ison	propyl alcohol			
Remarks	Cleaning conditions : 90s	. Immersion and cleaning.			
17.Thermal shock					
17.Thermal shock	LB, LBC, LBR, LBMF Series				
17.Thermal shock Specified Value	LB, LBC, LBR, LBMF Series CB, CBC, CBL, CBMF Series		Inductance change: Within±10%		
			Inductance change : Within±10% No significant abnormality in appearance.		
	CB, CBC, CBL, CBMF Series	·LBM·LBMF·CBMF:			
Specified Value	CB, CBC, CBL, CBMF Series LBM Series LB·LBC·LBR·CB·CBC·CBL				
Specified Value  Test Methods and	CB, CBC, CBL, CBMF Series  LBM Series  LB LBC LBR CB CBC CBL  The given sample is soldered to Condit	to the board and then its Inductions of 1 cycle	No significant abnormality in appearance.		
Specified Value  Test Methods and	CB, CBC, CBL, CBMF Series  LBM Series  LB·LBC·LBR·CB·CBC·CBL  The given sample is soldered to Condit  Step Temperature (%)	to the board and then its Inductions of 1 cycle  C) Duration (min)	No significant abnormality in appearance.		
Specified Value  Test Methods and	CB, CBC, CBL, CBMF Series  LBM Series  LB·LBC·LBR·CB·CBC·CBL  The given sample is soldered to Condit  Step Temperature (% 1 -40±3)	to the board and then its Inductations of 1 cycle  C) Duration (min)  30±3	No significant abnormality in appearance.		
Specified Value  Test Methods and	CB, CBC, CBL, CBMF Series  LBM Series  LB·LBC·LBR·CB·CBC·CBL  The given sample is soldered to Condit  Step Temperature (%)	to the board and then its Inductations of 1 cycle  C) Duration (min)  30±3	No significant abnormality in appearance.		
Specified Value  Test Methods and	CB, CBC, CBL, CBMF Series  LBM Series  LB·LBC·LBR·CB·CBC·CBL  The given sample is soldered to Condit  Step Temperature (% 1 -40±3)  2 Room temperature	to the board and then its Inductations of 1 cycle  C) Duration (min) $30\pm 3$ ure Within 3 $30\pm 3$	No significant abnormality in appearance.		
Specified Value  Test Methods and	CB, CBC, CBL, CBMF Series  LBM Series  LB·LBC·LBR·CB·CBC·CBL  The given sample is soldered to Condition  Step Temperature (% 1 -40±3)  2 Room temperature  3 +85±2  4 Room temperature	to the board and then its Inductations of 1 cycle  C) Duration (min) $30\pm 3$ ure Within 3 $30\pm 3$ ure Within 3	No significant abnormality in appearance.		

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18.Damp heat life to	est				
	LB, LBC, LBR, LBMF Series				
Specified Value	CB, CBC, CBL, CBMF Series		Inductance change : Within±10%		
	LBM Series		No significant abnormality in appearance.		
	Temperature	: 60±2°C			
Test Methods and	Humidity	: 90~95%RH			
Remarks	Duration	: 1000 hrs	and and any distinct after the test followed by the mass warrant within 10 has		
	Recovery	: At least 2 hrs of recovery under the sta	andard condition after the test, followed by the measurement within 48 hrs.		
19.Loading under da	amp heat life test				
	LB, LBC, LBR, LBM	F Series			
	CB, CBC, CBL, CBN	MF Series	Inductance change : Within±10%		
Specified Value	LBM Series		No significant abnormality in appearance.		
Test Methods and	Temperature	: 60±2°C	<u> </u>		
Remarks	Humidity	: 90~95%RH			
	Duration	: 1000 hrs			
	Applied current Recovery	: Rated current : At least 2 hrs of recovery under the sta	andard condition after the test, followed by the measurement within 48 hrs.		
	. 10001019	isase 2 in 3 or recovery under the ste	and a serial distriction of the cost, followed by the measurement within 40 IIIs.		
20.High temperature	e life test				
	LB, LBC, LBR, LBM	F Series	-		
Specified Value	CB, CBC, CBL, CBN	MF Series	Inductance change : Within±10%		
	LBM Series		No significant abnormality in appearance.		
Test Methods and	Temperature	: 85±2°C			
Remarks	Duration : 1000 hrs				
	Recovery	: At least 2 hrs of recovery under the sta	andard condition after the test, followed by the measurement within 48 hrs.		
21 Loading at high t	temperature life test				
21.Loading at high t	lemperature me test		Indicators a house i Within to 1004		
	LB, LBC, LBR, LBM	F Series	Inductance change: Within±10% (LBC3225 Series: Within±20%)		
Specified Value			No significant abnormality in appearance.		
·	CB, CBC, CBL, CBN	MF Series			
	LBM Series				
	Temperature	: 85±2°C			
Test Methods and	Duration	: 1000 hrs			
Remarks	Applied current : Rated current Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48				
	1	,			
22.Low temperature	e life test				
	LB, LBC, LBR, LBM	F Series			
Specified Value	CB, CBC, CBL, CBN	MF Series	Inductance change: Within±10%		
	LBM Series		No significant abnormality in appearance.		
T . M .!	Temperature	: -40±2°C			
Test Methods and Remarks	Duration : 1000 hrs				
	Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.				
	on				
23.Standard conditi	1		Standard test conditions		
23.Standard conditi	LB, LBC, LBR, LBM	F Series			
23.Standard conditi		F Series	Unless specified, Ambient temperature is 20±15°C and the Relative		
23.Standard conditi					
	LB, LBC, LBR, LBM		Unless specified, Ambient temperature is $20\pm15^{\circ}\text{C}$ and the Relative humidity is $65\pm20\%$ . If there is any doubt about the test results, further measurement shall be had within the following limits:  Ambient Temperature: $20\pm2^{\circ}\text{C}$		
	LB, LBC, LBR, LBM		Unless specified, Ambient temperature is $20\pm15^{\circ}\text{C}$ and the Relative humidity is $65\pm20\%$ . If there is any doubt about the test results, further measurement shall be had within the following limits:  Ambient Temperature: $20\pm2^{\circ}\text{C}$ Relative humidity: $65\pm5\%$		
	LB, LBC, LBR, LBM		Unless specified, Ambient temperature is $20\pm15^{\circ}\text{C}$ and the Relative humidity is $65\pm20\%$ . If there is any doubt about the test results, further measurement shall be had within the following limits:  Ambient Temperature: $20\pm2^{\circ}\text{C}$		

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# WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

#### **PRECAUTIONS**

#### 1. Circuit Design

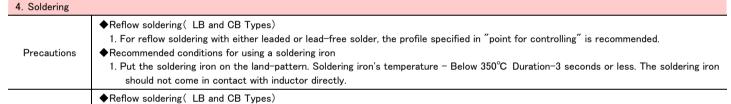
#### ◆Operating environment

#### Precautions

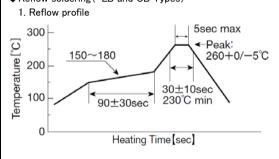
1. The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.

# Precautions Technical considerations PRECAUTIONS [Recommended Land Patterns] Surface Mounting • Mounting and soldering conditions should be checked beforehand. • Applicable soldering process to those products is reflow soldering only.

3. Considerations	3. Considerations for automatic placement		
Precautions	◆Adjustment of mounting machine 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand.		
Technical considerations	1. When installing products, care should be taken not to apply distortion stress as it may deform the products.		







- ◆Recommended conditions for using a soldering iron
  - 1. Components can be damaged by excessive heat where soldering conditions exceed the specified range.

# 5. Cleaning Precautions Cleaning conditions Washing by supersonic waves shall be avoided. Technical considerations If washed by supersonic waves, the products might be broken.

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6. Handling	
Precautions	<ul> <li>✦Handling</li> <li>1. Keep the inductors away from all magnets and magnetic objects.</li> <li>✦Breakaway PC boards(splitting along perforations)</li> <li>1. When splitting the PC board after mounting inductors, care should be taken not to give any stresses of deflection or twisting to the board.</li> <li>2. Board separation should not be done manually, but by using the appropriate devices.</li> <li>✦Mechanical considerations</li> <li>1. Please do not give the inductors any excessive mechanical shocks.</li> </ul>
Technical considerations	<ul> <li>✦Handling</li> <li>1. There is a case that a characteristic varies with magnetic influence.</li> <li>✦Breakaway PC boards (splitting along perforations)</li> <li>1. Planning pattern configurations and the position of products should be carefully performed to minimize stress.</li> <li>✦Mechanical considerations</li> <li>1. There is a case to be damaged by a mechanical shock.</li> </ul>

#### 7. Storage conditions **♦**Storage 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. · Recommended conditions Ambient temperature : 0~40°C Precautions Humidity: Below 70% RH • The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may For this reason, product should be used within 6 months from the time of delivery. In case of storage over 6 months, solderability shall be checked before actual usage. **♦**Storage Technical 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes considerations and deterioration of taping/packaging materials may take place.

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